

### Features

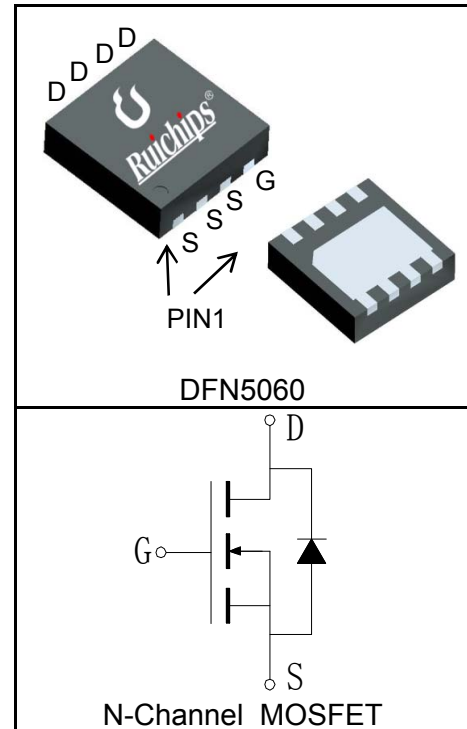
- 40V/190A,  
 $R_{DS(ON)} = 1.7m\Omega(Typ.)@V_{GS}=10V$
- Uses Ruichips Proprietary New Trench Technology
- Ultra Low On-Resistance
- Exceptional dv/dt Capability
- Low Gate Charge Minimize Switching Loss
- 100% Avalanche Tested
- Lead Free and Green Devices (RoHS Compliant)



### Applications

- DC/DC Converters
- On board power for servers
- Fast charges

### Pin Description



### Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit	
<b>Common Ratings</b> ( $T_C=25^\circ C$ Unless Otherwise Noted)				
$V_{DSS}$	Drain-Source Voltage	40	V	
$V_{GSS}$	Gate-Source Voltage	$\pm 20$		
$T_J$	Maximum Junction Temperature	175	$^\circ C$	
$T_{STG}$	Storage Temperature Range	-55 to 175	$^\circ C$	
$I_S$	Diode Continuous Forward Current	$T_C=25^\circ C$	190	A
<b>Mounted on Large Heat Sink</b>				
$I_{DP}^{①}$	300 $\mu s$ Pulse Drain Current Tested	$T_C=25^\circ C$	560	A
$I_D^{②}$	Continuous Drain Current@ $T_C(V_{GS}=10V)$	$T_C=25^\circ C$	190	A
		$T_C=100^\circ C$	125	
	Continuous Drain Current@ $T_A(V_{GS}=10V)^{③}$	$T_A=25^\circ C$	23	
		$T_A=70^\circ C$	18	
$P_D$	Maximum Power Dissipation@ $T_C$	$T_C=25^\circ C$	174	W
		$T_C=100^\circ C$	70	
	Maximum Power Dissipation@ $T_A^{③}$	$T_A=25^\circ C$	2.5	
		$T_A=70^\circ C$	1.6	

Symbol	Parameter	Rating	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	0.72	°C/W
$R_{\theta JA}^{③}$	Thermal Resistance-Junction to Ambient	50	°C/W
<b>Drain-Source Avalanche Ratings</b>			
$E_{AS}^{④}$	Avalanche Energy, Single Pulsed	225	mJ

**Electrical Characteristics** ( $T_C=25^\circ\text{C}$  Unless Otherwise Noted)

Symbol	Parameter	Test Condition	RUH40190M			Unit
			Min.	Typ.	Max.	
<b>Static Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_{DS}=250\mu A$	40			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=40V, V_{GS}=0V$			1	$\mu A$
		$T_J=125^\circ C$			30	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_{DS}=250\mu A$	2		4	V
$I_{GSS}$	Gate Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			$\pm 100$	nA
$R_{DS(ON)}^{⑤}$	Drain-Source On-state Resistance	$V_{GS}=10V, I_{DS}=50A$		1.7	2.2	$m\Omega$
		$T_J=125^\circ C$		2.9	3.5	$m\Omega$
<b>Diode Characteristics</b>						
$V_{SD}^{⑤}$	Diode Forward Voltage	$I_{SD}=50A, V_{GS}=0V$		0.9	1.2	V
$t_{rr}$	Reverse Recovery Time	$I_{SD}=50A, dI_{SD}/dt=100A/\mu s$		22.5		ns
$Q_{rr}$	Reverse Recovery Charge			12		nC
<b>Dynamic Characteristics</b> <sup>⑥</sup>						
$R_G$	Gate Resistance	$V_{GS}=0V, V_{DS}=0V, F=1MHz$		0.8		$\Omega$
$C_{iss}$	Input Capacitance	$V_{GS}=0V,$ $V_{DS}=20V,$ Frequency=1.0MHz		5050		pF
$C_{oss}$	Output Capacitance			910		
$C_{rss}$	Reverse Transfer Capacitance			850		
$t_{d(ON)}$	Turn-on Delay Time	$V_{DD}=20V, I_{DS}=50A,$ $V_{GEN}=10V, R_G=4.7\Omega$		27		ns
$t_r$	Turn-on Rise Time			34		
$t_{d(OFF)}$	Turn-off Delay Time			76		
$t_f$	Turn-off Fall Time			16		
<b>Gate Charge Characteristics</b> <sup>⑥</sup>						
$Q_g$	Total Gate Charge	$V_{DS}=32V, V_{GS}=10V,$ $I_{DS}=50A$		135		nC
$Q_{gs}$	Gate-Source Charge			21		
$Q_{gd}$	Gate-Drain Charge			31		

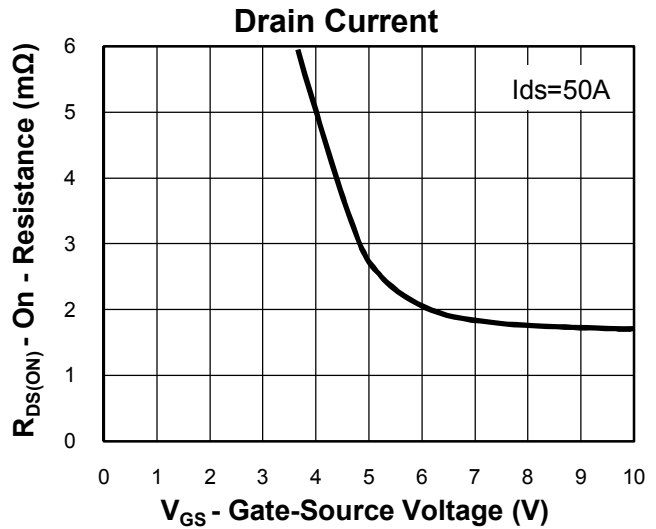
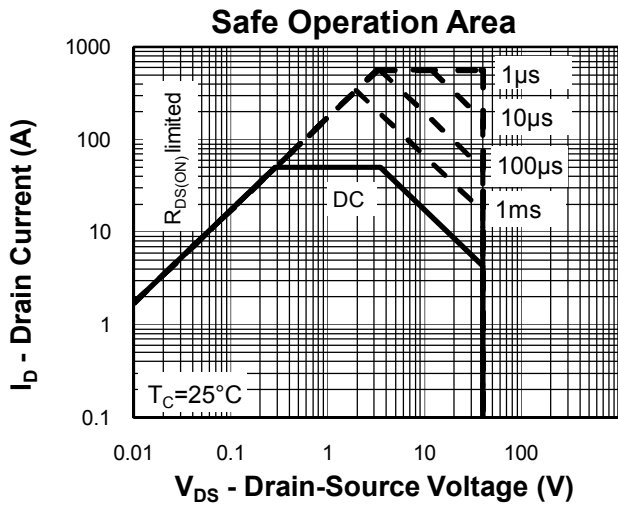
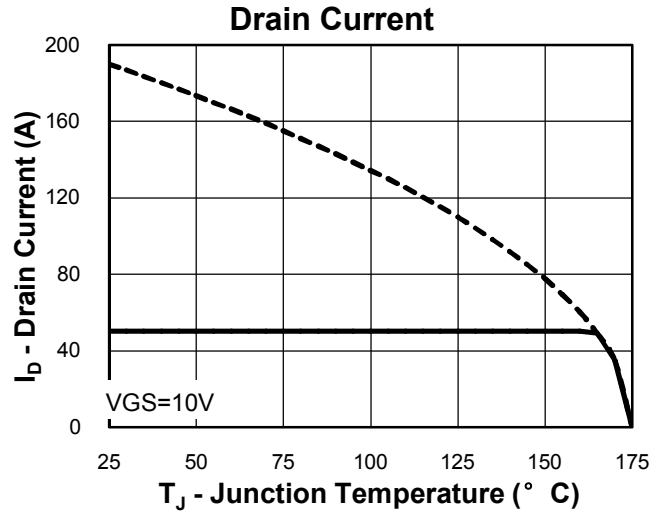
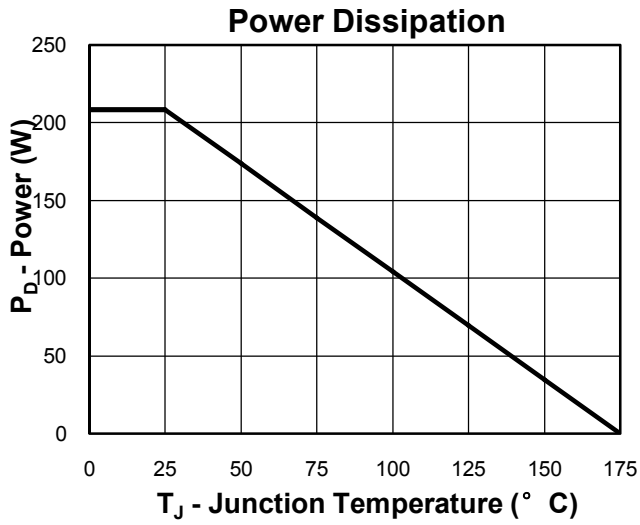
**Notes:**

- ①Pulse width limited by safe operating area.
- ②Calculated continuous current based on maximum allowable junction temperature. The package limitation current is 50A.
- ③When mounted on 1 inch square copper board,  $t \leq 10\text{sec}$ .
- ④Limited by  $T_{J\text{max}}$ ,  $I_{AS} = 30\text{A}$ ,  $V_{DD} = 32\text{V}$ ,  $R_{\theta} = 50\Omega$ , Starting  $T_J = 25^\circ\text{C}$ .
- ⑤Pulse test; Pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
- ⑥Guaranteed by design, not subject to production testing.

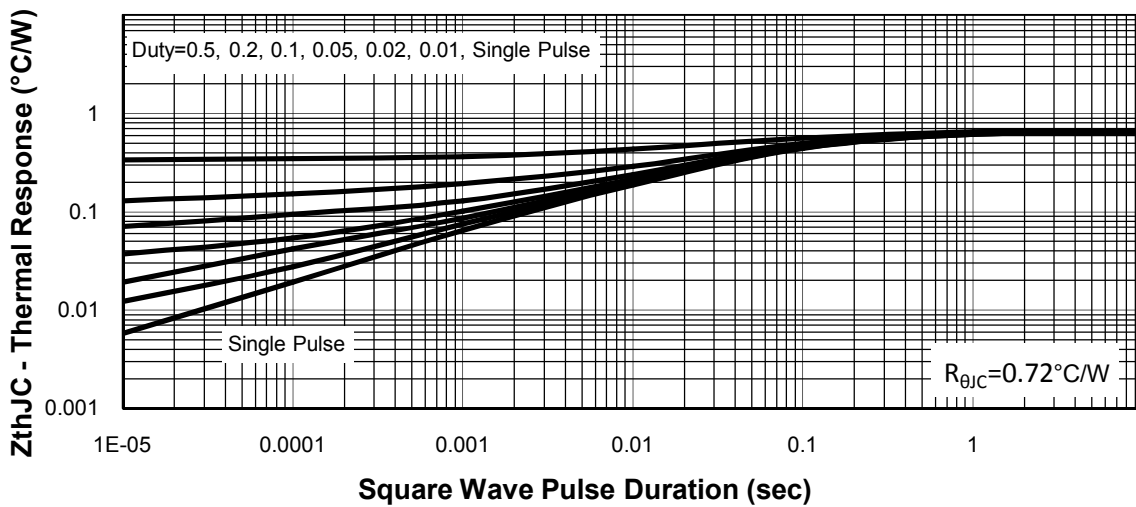
**Ordering and Marking Information**

<b>Device</b>	<b>Marking</b>	<b>Package</b>	<b>Packaging</b>	<b>Quantity</b>	<b>Reel Size</b>	<b>Tape width</b>
RUH40190M	RUH40190M	DFN5060	Tape&Reel	5000	13"	12mm

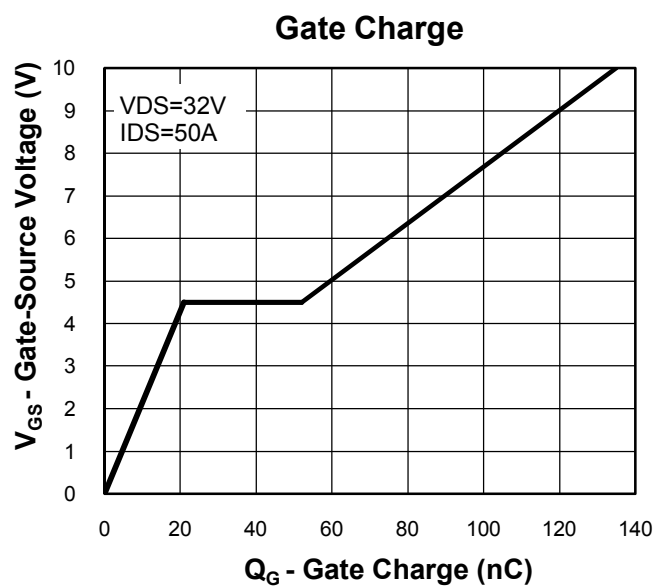
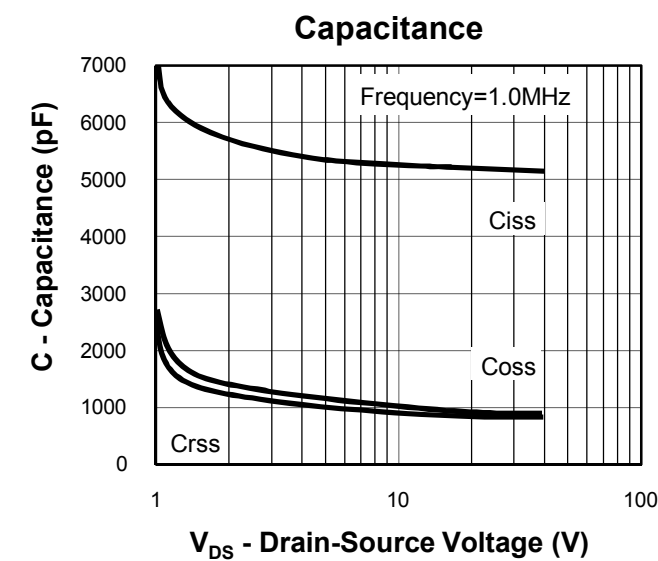
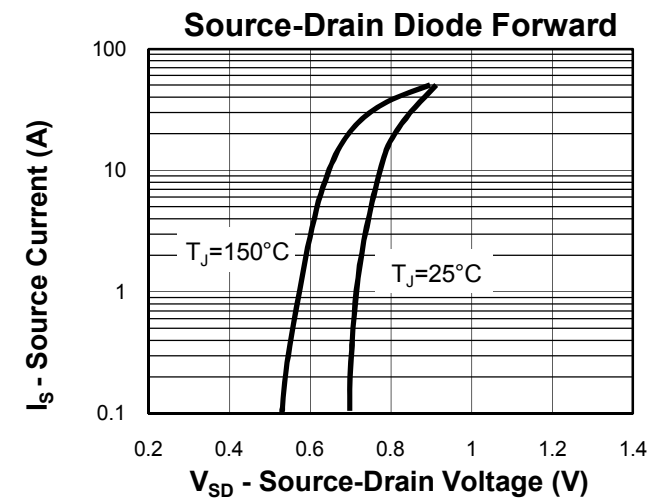
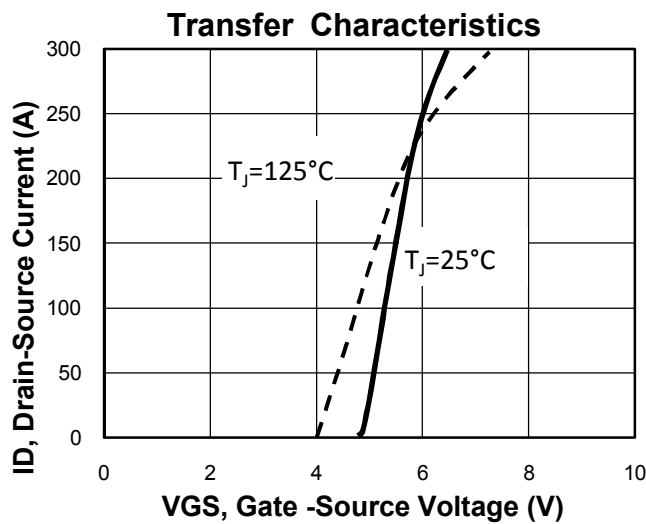
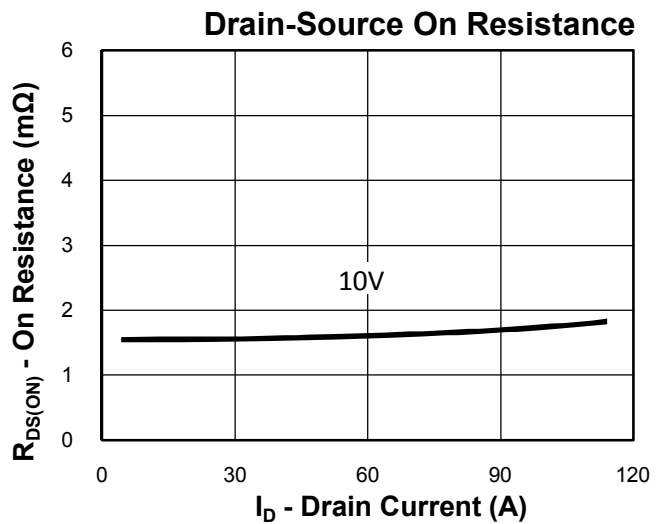
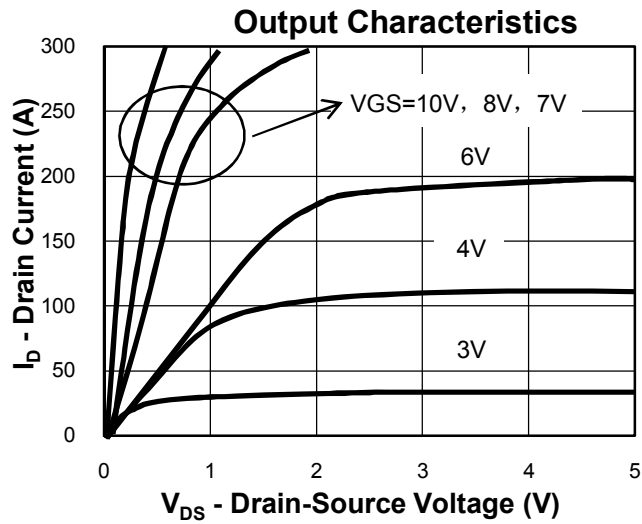
**Typical Characteristics**



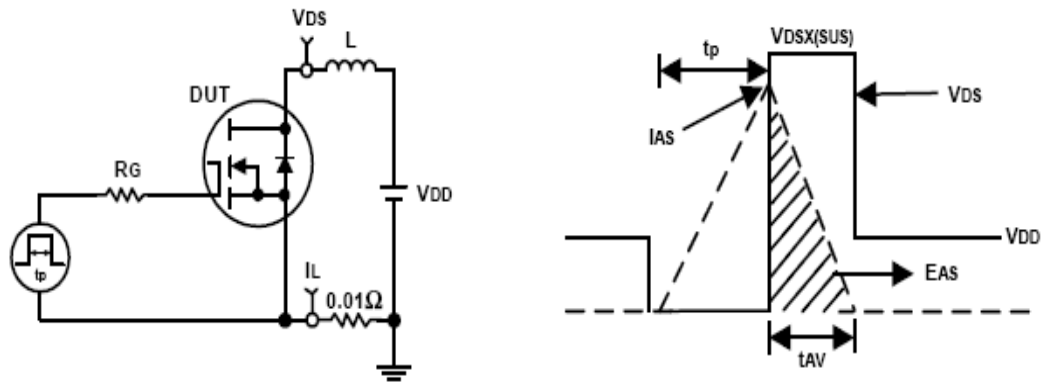
**Thermal Transient Impedance**



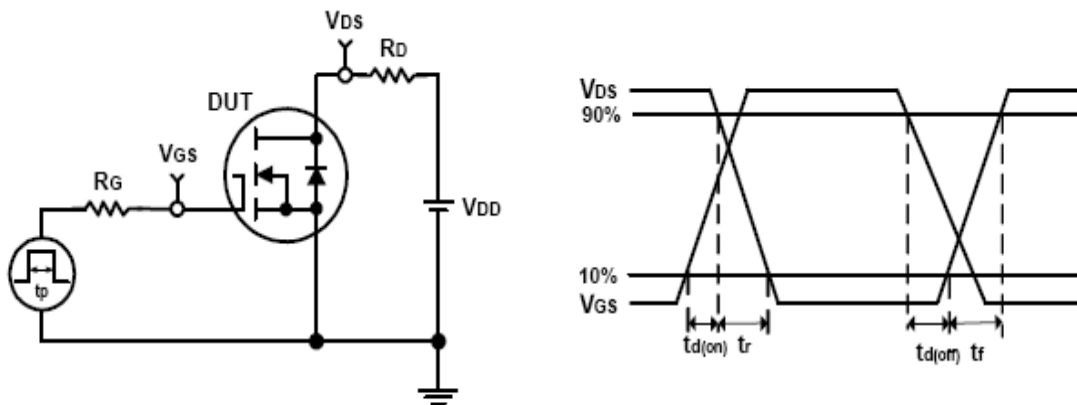
**Typical Characteristics**



**Avalanche Test Circuit and Waveforms**

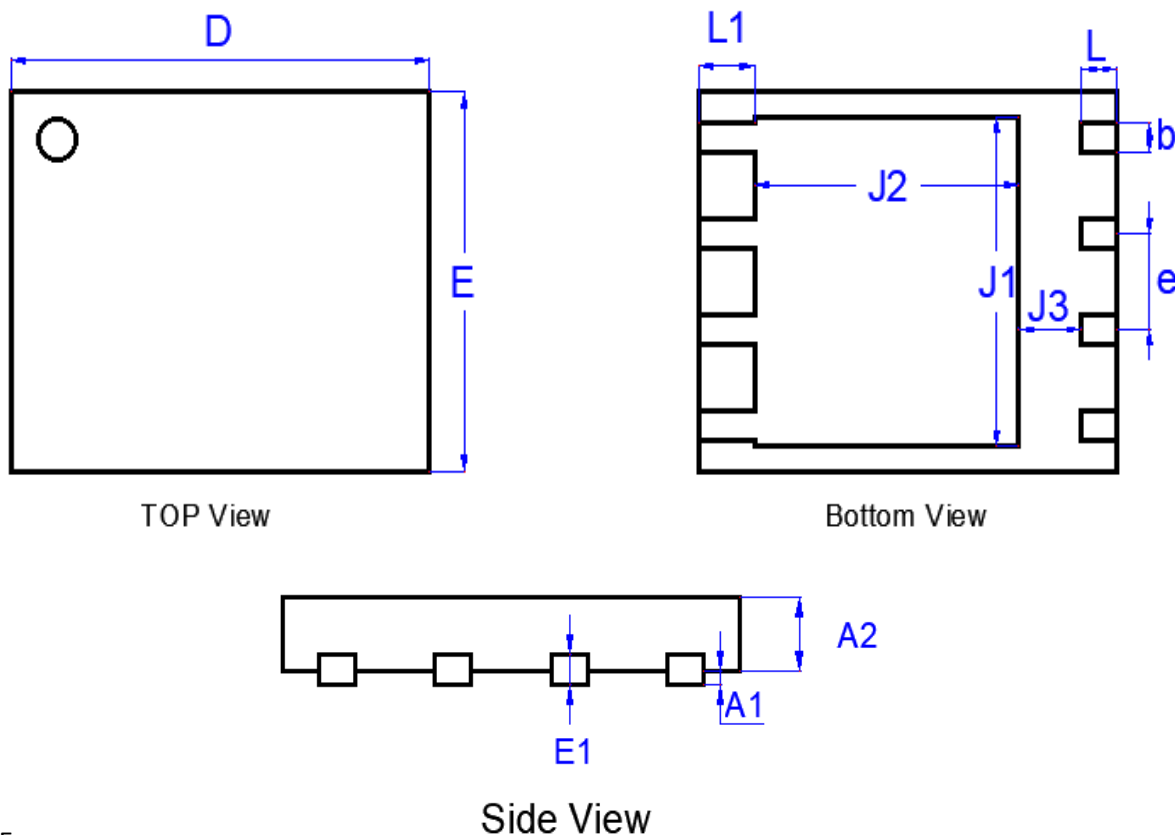


**Switching Time Test Circuit and Waveforms**



**Package Information**

**DFN5060**



**NOTE:**

- 1: ALL UNITS ARE IN MILLIMETER.
- 2: EJECTOR PIN MARK POSITION MAY VARY FROM DIFFERENT MOLD.
- 3: ALL DIMENSIONS REFER TO JEDEC.DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.

SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
A1	-	-	0.15	-	-	0.006
A2	0.70	0.75	0.80	0.028	0.030	0.031
E1	0.185	0.235	0.285	0.007	0.009	0.011
b	0.350	0.400	0.450	0.014	0.016	0.018
e	1.220	1.270	1.320	0.048	0.050	0.052
D	5.900	6.000	6.100	0.232	0.236	0.240
E	4.900	5.000	5.100	0.193	0.197	0.201
J1	4.300	4.360	4.420	0.169	0.172	0.174
J2	3.700	3.800	3.900	0.146	0.150	0.154
J3	0.800	0.900	0.950	0.031	0.035	0.037
L	0.450	0.515	0.565	0.018	0.020	0.022
L1	0.750	0.800	0.850	0.030	0.031	0.033